ASSOCIATION CONNECTING ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® international and Pa	IPC. Bannockt	ourn. Illinois. A	Il rights reserved ur ntions.	nder both	This docume level parts, t	ent is a declaration en	on of the subst acompasses al	ances within the manu lower level materials	facturer liste	d item. Note: if e manufacturer	the item is an as has engineering	ssembly with low responsibility.	
	.1 IPC Web Site for Information on IPC-1752 Standard Form Dist.				Type * Declaration Class * ute Class 6 - RoHS Yes/No, Homogeneous Mater				laterials and	rials and Mfg Information			
Supplier Information													
Company name* Company			npany unique ID			Unique ID Authority				Response Date*			
nsemi										2024-05-01			
Contact Name Title - Contact			t J		Phone - Contact*			Emai	Email - Contact*				
Product-Env-Stewards Product Envi			nviro Compliance		NA			Prod	Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repres			presentative		Phone - Representative*			Emai	Email - Representative*				
Product-Env-Stewards Product Er			uct Enviro Compliance			NA			Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item	Number	Mfr Item Name			Effective Date	Version	Manufacturing Si	Manufacturing Site		UOM	Unit Type	
	FSEZ10	FSEZ1016AMY PSR P		PSR PWM Cntlr with MOSFET		2024-05-01		TAD	TAD		mg	Each	
Aanufacturing Proccess Informa	ition					• 	-				•		
Terminal Plating / Grid Array M	aterial T	Cerminal Base	Alloy J-	J-STD-020 MSL Rating		Peak Process Body Temperature		erature Max Time at	Peak Tempe	erature Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed CU Alloy		3			260	C	30	sec	conds 3				
omments													
FTENTION: MSL 3 Rated item require	es Bake and D	ry Pack (after	electrical test)										
or more information regarding material	composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl ohthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	3.59	mg	Supplier	Silicon (Si)	7440-21-3		3.59	mg
Die Attach	0.428	mg	Supplier	Silver (Ag)	7440-22-4		0.336	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.092	mg
Lead Frame	33.025	mg	Supplier	Silver (Ag)	7440-22-4		0.077	mg
			Supplier	Zinc (Zn)	7440-66-6		0.043	mg
			Supplier	Iron (Fe)	7439-89-6		0.792	mg
			Supplier	Copper (Cu)	7440-50-8		32.1	mg
			Supplier	Phosphorus (P)	7723-14-0		0.013	mg
Mold Compound-Black	51.184	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		14.8	mg
			Supplier	Carbon Black (C)	1333-86-4		0.384	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		36	mg
Plating	0.985	mg	Supplier	Tin (Sn)	7440-31-5		0.985	mg
Wire Bond - Au	0.199	mg	Supplier	Gold (Au)	7440-57-5		0.199	mg